

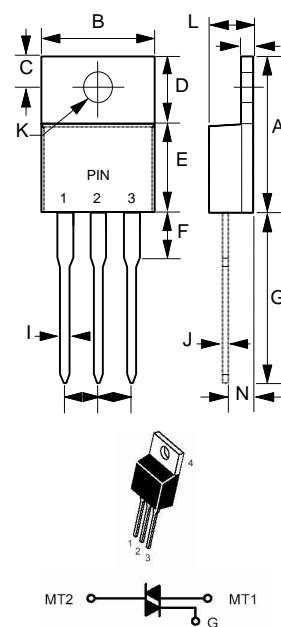
**Sensitive Gate Triacs
Silicon Bidirectional Thyristors**

**TRIACS
16 AMPERES RMS
400 thru 800 VOLTS**

FEATURES

- Sensitive Gate allows Triggering by Microcontrollers and other
- Maximum Values of IGT, VGT and IH Specified for Ease of Design
- On-State Current Rating of 15 A RMS at 70
- High Surge Current Capability - 120 A
- Blocking Voltage to 800 V
- Uniform Gate Trigger Currents in Three Quadrants, Q1, Q2, and Q3
- Pb Free Package

TO-220AB



TO-220AB		
DIM.	MIN.	MAX.
A	14.22	15.88
B	9.65	10.67
C	2.54	3.43
D	5.84	6.86
E	8.26	9.28
F	-	6.35
G	12.70	14.73
H	2.29	2.79
I	0.51	1.14
J	0.40	0.67
K	3.53 Ø	4.09 Ø
L	3.56	4.83
M	1.14	1.40
N	2.03	2.92

All Dimensions in millimeter

PIN ASSIGNMENT	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

MAXIMUM RATINGS ($T_j = 25^\circ C$ unless otherwise noticed)

Rating	Symbol	Value	Unit
Peak Repetitive Off- State Voltage (1) ($T_j = -40$ to $110^\circ C$, Sine Wave, 50 to 60 Hz; Gate Open)	V_{DRM} , V_{RRM}	400 600 800	Volts
On-State RMS Current ($T_c = +70^\circ C$) Full Cycle Sine Wave 50 to 60 Hz	$I_{T(RMS)}$	16	Amp
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_j = +25^\circ C$) Preceded and followed by rated current.	I_{TSM}	120	Amps
Circuit Fusing Consideration ($t = 8.3$ ms)	I^2t	93	A^2s
Peak Gate Power ($T_c = +70^\circ C$, $T_p = 1.0$ us)	P_{GM}	20	Watt
Average Gate Power ($T_c = +70^\circ C$, $t=8.3$ ms)	$P_{G(AV)}$	0.5	Watt
Operating Junction Temperature Range	T_J	-40 to +110	
Storage Temperature Range	T_{stg}	-40 to +150	

Notice: (1) V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

REV. 0, Sep-2005,KTXC22

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case - Junction to Ambient	R _{thJC} R _{thJA}	2.0 62.5	/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T _L	260	

ELECTRICAL CHARACTERISTICS (T_c=25 °C unless otherwise noted, Electrical apply in both directions)

Characteristics	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Peak Repetitive Forward or Reverse Blocking Current (V _D =Rated V _{DRM} , V _{RRM} ; Gate Open)	T _J =25 T _J =110	I _{DRM} I _{RRM}	— —	— —	0.01 2.0	mA
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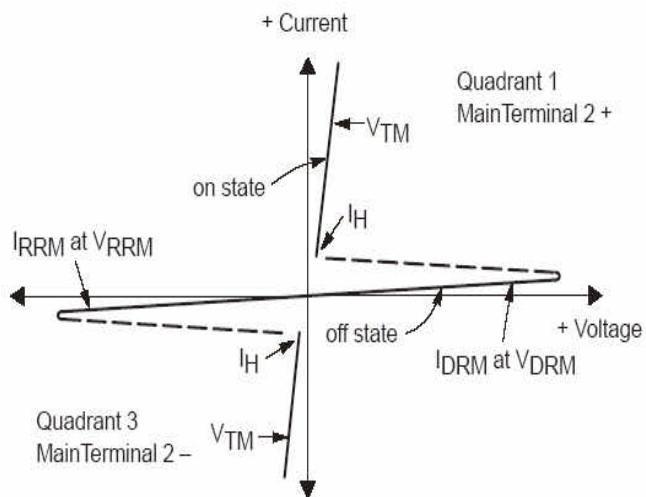
ON CHARACTERISTICS

Peak On-State Voltage (I _{TM} =± 21 A Peak @T _p = 2.0 ms, Duty Cycle = 2%)	V _{TM}	----	----	1.8	Volts
Gate Trigger Current (Continuous dc) (V _D = 12Vdc; R _L = 100 Ohms)	I _{GT1} I _{GT2} I _{GT3}	---- --- ---	2.0 3.0 3.0	5.0 5.0 5.0	mA
Gate Trigger Voltage (Continuous dc) (V _D = 12 Vdc; R _L = 100 Ohms)	V _{GT1} V _{GT2} V _{GT3}	0.45 0.45 0.45	0.62 0.60 0.65	1.5 1.5 1.5	Volts
Holding Current (V _D = 12 V, Initiating Current = ± 150 mA, Gate Open)	I _H	----	3.0	10	mA
Latching Current (V _D = 24 V, I _G = 50 mA)	I _L	---- --- ---	5.0 10 5.0	15 20 15	mA

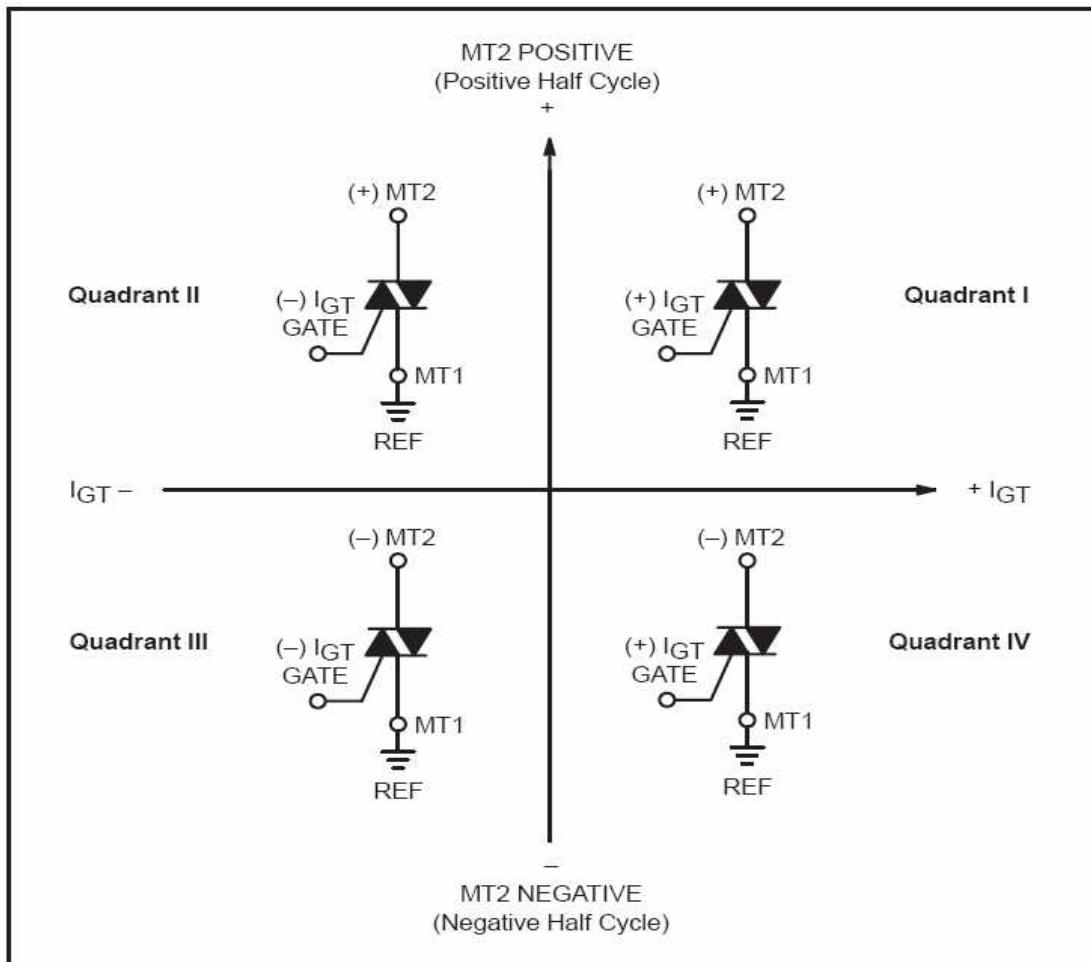
DYNAMIC CHARACTERISTICS

Critical Rate of Change of Commutation Current (V _D = Rated V _{DRM} , I _{TM} = 3.5 A, Commutating dv/dt = 10 V/us, Gate Unenergized, T _C = 110 °C, f = 250 Hz, Snubber: C _s = 0.01 μF, R _s = 15 Ohms)	di/dt(c)	8.0	10	----	A/ms
Critical Rate of Rise of Commutation Voltage (V _D = 67% V _{DRM} , Exponential Waveform, R _{GK} = 510 Ohms, T _C = 110 °C)	dv/dt	25	75	----	V/us

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I_H	Holding Current



Quadrant Definitions

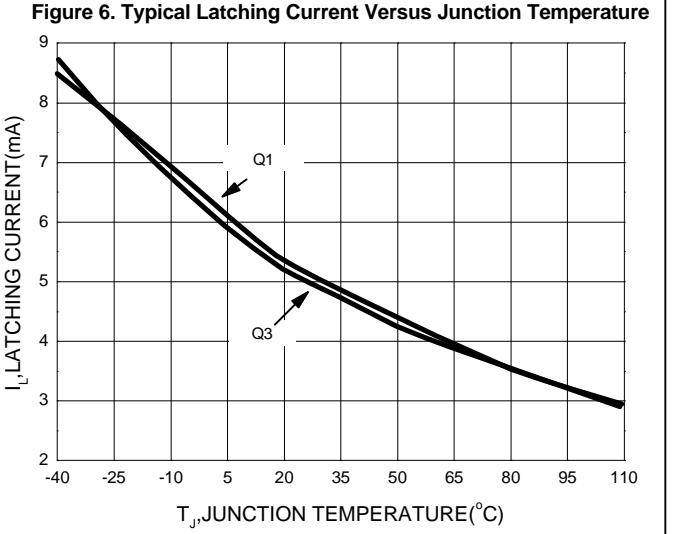
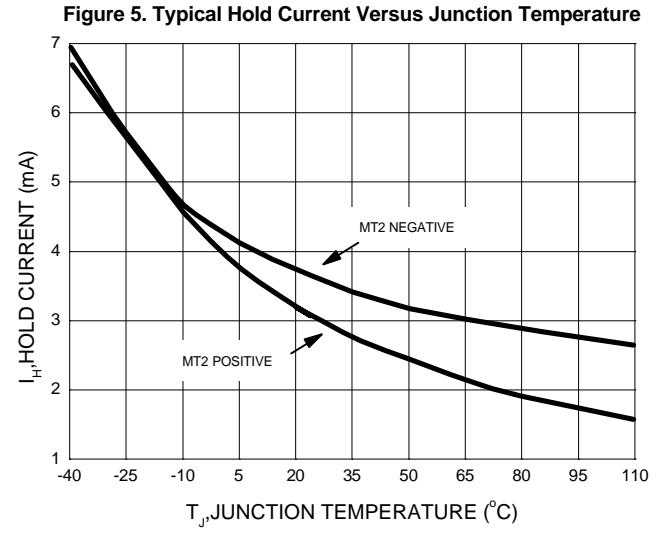
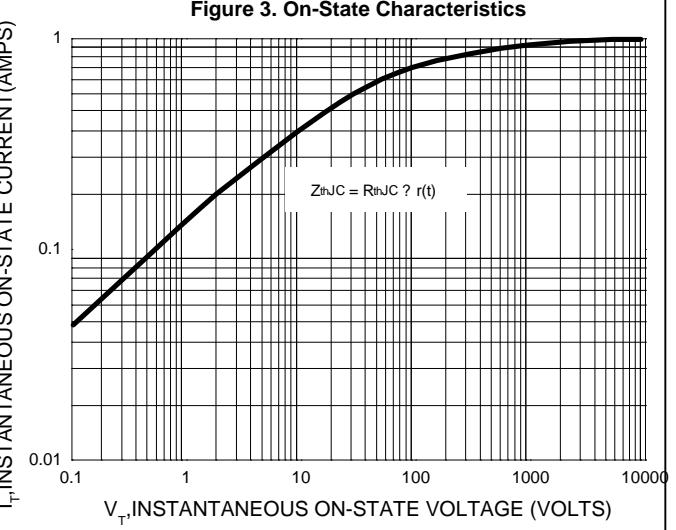
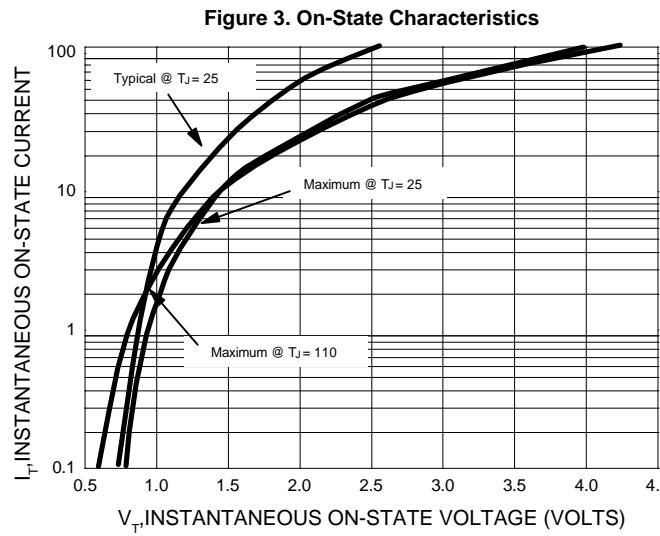
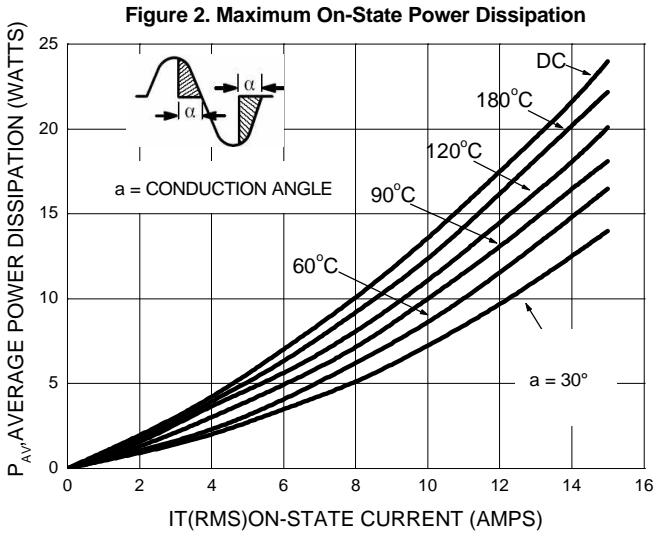
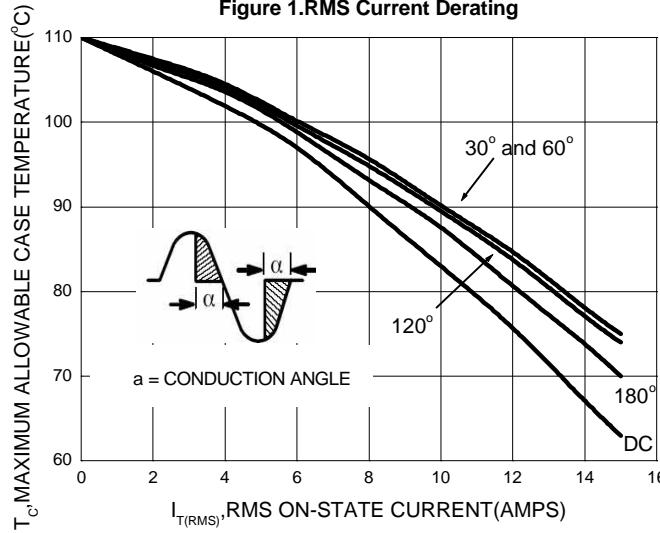


All polarities are referenced to MT1

Whith in -phase signal (using standard AC lines) quadrants I and III are used

RATING AND CHARACTERISTIC CURVES
T16M5T-B SERIES

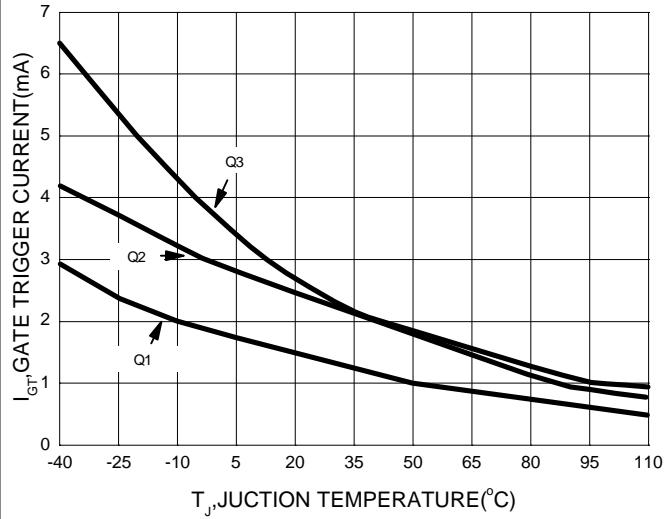
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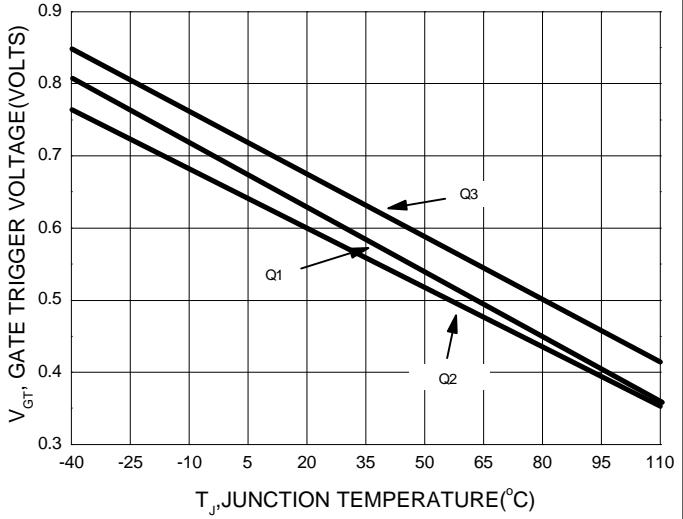
RATING AND CHARACTERISTIC CURVES
T16M5T-B SERIES

LITEON

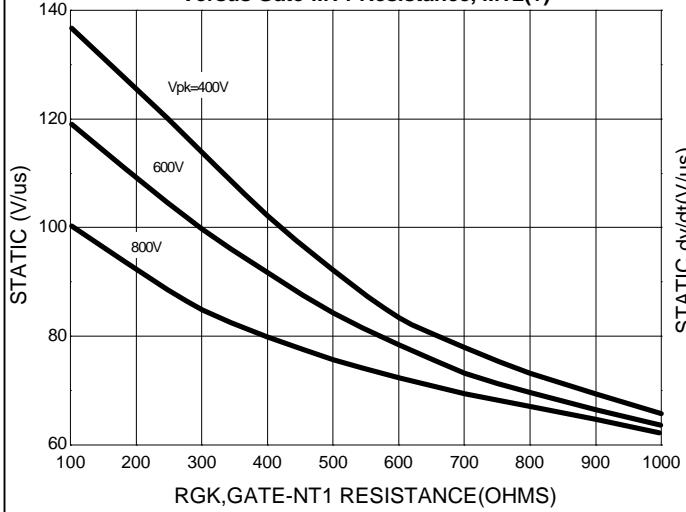
**Figure 7.Typical Gate Trigger Current
Versus Junction emperature**



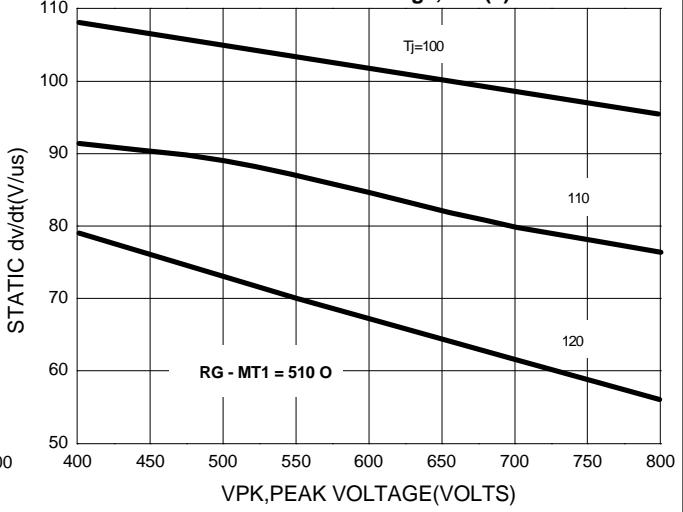
**Figure 8.Typical Gate Trigger Voltage
Versus Junction Temperature**



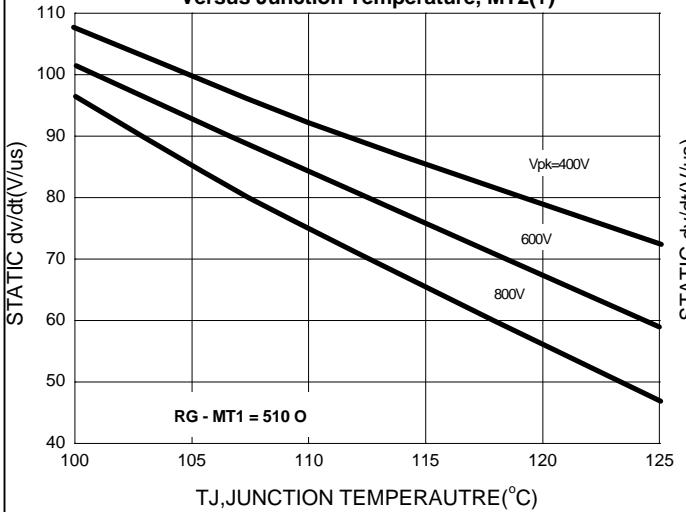
**Figure 9. Typical Exponential Static dv/dt
Versus Gate-MT1 Resistance, MT2(+)**



**Figure 10. Typical Exponential Static dv/dt
Versus Peak Voltage,MT2(+)**



**Figure 11. Typical Exponential Static dv/dt
Versus Junction Temperature, MT2(+)**



**Figure 12. Typical Exponential Static dv/dt
Versus Peak Voltage,MT2(-)**

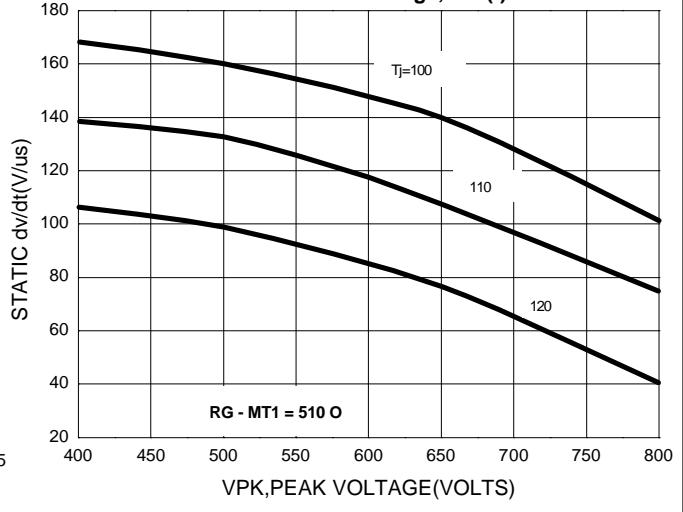


Figure 13. Typical Exponential Static dv/dt Versus Junction Temperature, MT2(-)

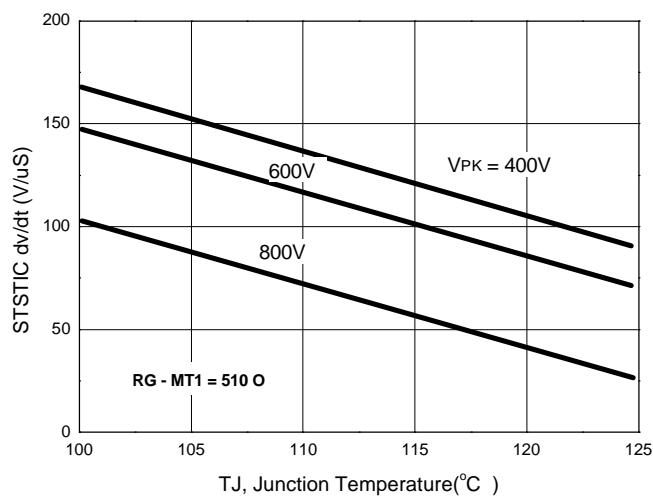


Figure 14. Critical Rate of Rise of Commutating Voltage

